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General Information

Series	SMD Comm X7R FE
Style	SMD Chip
Description	SMD, MLCC, FE-CAP, Floating Electrode, Temperature Stable
Features	FE-CAP, Floating Electrode, Temperature Stable
RoHS	Yes
Termination	Tin
Marking	No
Typical Component Weight	185 mg
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	1.8 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	20%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%
Dissipation Factor	3.5% 1 kHz 1.0Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	555.6 MOhms

Dimensions

L	4.5mm +/-0.3mm
W	3.2mm +/-0.3mm
T	1.6mm +/-0.2mm
S	2.3mm MIN
B	0.6mm +/-0.35mm
Case Code (EIA / mm)	1812 / 4532

Packaging Specifications

Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	4000

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